

LOW ON-RESISTANCE HOT SWAP POWER MA

SLUS384B - NOVEMBER 1999 - REVISED JUNE 2000

 Integrated 0.075-Ω Power MOSFET 3 V to 6 V Operation 	DP PAC (TOP \	-
 External Analog Control of Fault Current from 0 A to 4 A 	VIN ☐ 1 ○ VIN ☐ 2	16 VOUT 15 VOUT
 Independent Analog Control of Current Limit Up to 5 A 	VIN 3 GND* 4	14
Fast Overload Protection	GND*	12 GND* 11 DNC
Unidirectional Switch	SHTDWN T	10 CT
Minimal External Components	IFAULT 📖 8	9 D IMAX

Pin 5 serves as the lowest impedance to the electrical ground. Pins 4, 12, and 13, serve as heat sink/ground. These pins should be connected to large etch PCB areas to help dissipate heat.

- **Minimal External Components**
- 1-μA I_{CC} When Disabled
- **Programmable On Time**
- **Programmable Start Delay**
- **Fixed 3% Duty Cycle**

description

The UCC3918 low on-resistance hot swap power manager provides complete power management, hot swap capability, and circuit breaker functions. The only components needed to operate the device, other than supply bypassing, are a timing capacitor, and two programming resistors. All control and housekeeping functions are integrated, and externally programmable. These include the fault current level, maximum output sourcing current, maximum fault time, and startup delay. In the event of a constant fault, the internal fixed 3% duty cycle ratio limits the average output power. The IFAULT pin allows linear programming of the fault level current from 0 A to 4 A.

Fast overload protection is accomplished by an additional overload comparator. Its threshold is internally set above the maximum sourcing current limit setting. In the event of a short circuit or extreme current condition, this comparator is tripped, shutting down the output. This function is needed since the maximum sourcing current limit loop has a finite bandwidth.

When the output current is below the fault level, the output MOSFET is switched on with a nominal resistance of 0.075 Ω . When the output current exceeds the fault level or the maximum sourcing level, the output remains on, but the fault timer starts charging a capacitor connected to the CT pin (C_T). Once C_T charges to a preset threshold, the switch is turned off, and remains off for 30 times the programmed fault time. When the output current reaches the maximum sourcing level, the MOSFET transitions from a switch to a constant current source.

The UCC3918 is designed for unidirectional current flow, emulating an ideal diode in series with the power switch. This feature is particularly attractive in applications where many devices are powering a common bus, such as with SCSI termintation power (Termpwr). The UCC3918 can also be put into the sleep mode, drawing only 1 µA of supply current.

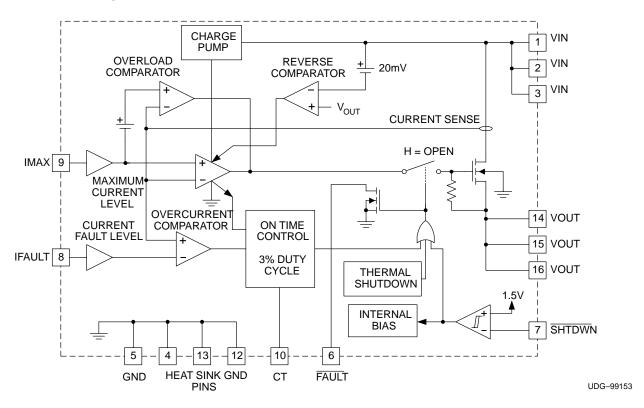
Other features include an open-drain fault output indicator, thermal shutdown, undervoltage lockout, 3 V to 6 V operation, and a low thermal resistance small-outline power package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



functional block diagram



absolute maximum ratings over operating free-air temperature (unless otherwise noted)^{†‡}

•	•	•		•	•
Input Voltage			 		8 V
SOIC Power dissipation			 		2.5 W
Fault output sink current			 		50 mA
Fault output voltage			 		VIN
Output Current (dc)			 		Internally Limited
Input Voltage SHTDWN, II	FAULT, IMAX		 		–0.3 V to VIN
Storage temperature range	T _{sta}		 		–65°C to 150°C
Operating virtual junction ter	mperature T	J	 		–55°C to 150°C
Lead temperature (soldering					

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



[‡] Unless otherwise indicated, voltages are reference to ground and currents are positive into, negative out of the specified terminal. Pulsed is defined as a less than 10% duty cycle with a maximum duration of 500 μs. Consult *Packaging Section* of Databook for thermal limitations and considerations of package.

electrical characteristics at T_A = 0°C to 70°C, VIN = 5 V, R_{IMAX} = 42.2 k Ω , R_{IFAULT} = 52.3 k Ω , SHTDWN = 2.4 V, T_A = T_J (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNITS
Supply Section					
Voltage input range, VIN		3	5	6	V
VDD supply current	No load		1	2	mA
Sleep mode current	SHTDWN = 0.2 V		0.5	5	μΑ
Output Section					
	$I_{OUT} = 1 \text{ A to } 4 \text{ A}, VIN = 5 \text{ V}, T_{A} = 25^{\circ}\text{C}$		0.075	0.095	Ω
	$I_{OUT} = 1 \text{ A to } 4 \text{ A}, VIN = 3 \text{ V}, T_{A} = 25^{\circ}\text{C}$		0.09	0.116	Ω
RDS(on)	$I_{OUT} = 1 A \text{ to } 4 A, VIN = 5 V$		0.075	0.125	Ω
	$I_{OUT} = 1A \text{ to } 4A, \qquad VIN = 3 \text{ V}$		0.09	0.154	Ω
Reverse leakage current	SHTDWN = 0 V, VIN = 0 V V _{OUT} = 5 V			20	μΑ
Initial startup time	See Note 1		100		μs
Thermal shutdown	VIN = 5 V, See Note 1		170		°C
Thermal hysteresis	See Note 1		10		°C
Output leakage	SHTDWN = 0.2 V, V _{OUT} = 0 V			20	μΑ
	R _{IFAULT} = 105 kΩ	0.75	1	1.25	Α
Trin command	$R_{IFAULT} = 52.3 \text{ k}\Omega$	1.7	2	2.3	Α
Trip current	$R_{IFAULT} = 34.8 \text{ k}\Omega$	2.5	3	3.5	Α
	$R_{IFAULT} = 25.5 \text{ k}\Omega$	3.3	4	4.7	Α
	$R_{\text{IMAX}} = 118 \text{ k}\Omega$	0.3	1	1.7	Α
	$R_{\text{IMAX}} = 60.4 \text{ k}\Omega$	1	2	3	Α
Maximum output current	$R_{\text{IMAX}} = 42.2 \text{ k}\Omega$	2	3	4	Α
	$R_{\text{IMAX}} = 33.2 \text{ k}\Omega$	2.5	3.8	5.1	Α
	$R_{\text{IMAX}} = 27.4 \text{ k}\Omega$	3.0	4.6	6.2	Α
Fault Section					
C _T charge current	V _{CT} = 1 V	-50	-36	-22	μΑ
C _T discharge current	V _{CT} = 1 V	0.5	1.2	2.0	μΑ
Output duty cycle	VOUT = 0 V	1.5	3	6	%
C _T fault threshold		0.8	1.3	1.8	V
C _T reset threshold		0.25	0.5	0.75	V
Shutdown Section					
Shutdown threshold		1.1	1.5	2.0	V
Shutdown hysteresis			100		mV
Input low current	SHTDWN = 0V	-500	0	500	nA
Input high current	SHTDWN = 2V	-2	-1	-0.5	μΑ
Open Drain Fault Output Section					_
High level output current				1	μΑ
Low level output voltage	I _{OUT} = 1mA		0.4	0.9	V

NOTE 1: Ensured by design. Not production tested.



pin descriptions

CT: A capacitor connected to this pin sets the maximum fault time. The maximum time must be greater than the time to charge external load capacitance. The nominal fault time is defined as:

$$T_{\text{FAULT}} = 22.2 \times 10^3 \times C_{\text{T}} \tag{1}$$

Once the fault time is reached the output shuts down for a time given by:

$$T_{SD} = 0.667 \times 10^6 \times C_T$$
 (2)

This equates to a 3% duty cycle. The recommended minimum value for the C_T capacitor is 0.1 μF.

FAULT: Open-drain output, which pulls low on any condition that causes the output to open; Fault, Thermal Shutdown, Shutdown, and maximum sourcing current greater than the fault time.

GND: This is the most negative voltage in the circuit. All 4 ground pins should be used, and properly heat sunk on the PCB.

IFAULT: A resistor connected from this pin to ground sets the fault threshold. The resistor versus fault current is set by the formula

$$R_{\mathsf{FAULT}} = \frac{105 \, \mathsf{k}\Omega}{\mathsf{I}_{\mathsf{TRIP}}} \tag{3}$$

IMAX: A resistor connected from this pin to ground sets the maximum sourcing current. The resistor vs the output sourcing current is set by the formula:

$$R_{\text{IMAX}} = \frac{126 \text{ k}\Omega}{\text{Maximum Sourcing Current}}$$
(4)

SHTDWN: When this pin is brought low, the IC is put into sleep mode. The input threshold is hysteretic, allowing the user to program a startup delay with an external RC circuit.

VIN: This is the input voltage to the UCC3918. The recommended operating voltage range is 3V to 6V. All VIN pins should be connected together and to the power source.

VOUT: Output voltage for the circuit breaker. When switched the output voltage will be approximately:

$$V_{OUT} = V_{IN} - 0.075\Omega \times I_{OUT}. \tag{5}$$

All VOUT pins should be connected together and to the load.



APPLICATION INFORMATION

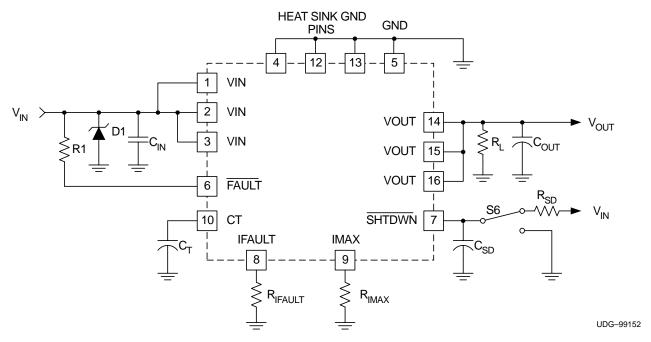


Figure 1. Typical Application

protecting the UCC3918 from voltage transients

The parasitic inductance associated with the power distribution can cause a voltage spike at V_{IN} if the load current is suddenly interrupted by the UCC3918. It is important to limit the peak of this spike to less than 6 V to prevent damage to the UCC3918. This voltage spike can be minimized by:

- Reducing the power distribution inductance (e.g., twist the positive "+" and negative "-" leads of the power supply feeding V_{IN}, locate the power supply close to the UCC3918 or use a PCB ground plane).
- Decoupling V_{IN} with a capacitor, C_{IN} (refer to Figure 1), located close to the VIN pin. This capacitor is typically less than 1 μ F to limit the inrush current.
- Clamping the voltage at V_{IN} below 6 V with a Zener diode, D1 (refer to Figure 1), located close to the VIN pin.

estimating maximum load capacitance

For circuit breaker applications, the rate at which the total output capacitance can be charged depends on the maximum output current available and the nature of the load. For a constant-current current-limited circuit breaker, the output comes up if the load requires less than the maximum available short-circuit current.

To ensure recovery of a duty-cycle of the current-limited circuit breaker from a short-circuited load condition, there is a maximum total output capacitance that can be charged for a given unit ON time (fault time). The design value of ON or fault time can be adjusted by changing the timing capacitor C_T .

APPLICATION INFORMATION

estimating maximum load capacitance

For worst-case constant-current load of value just less than the trip limit; C_{OUT(max)} can be estimated from:

$$C_{OUT(max)} = \left(I_{MAX} - I_{LOAD}\right) \left(\frac{22 \times 10^3 \times C_T}{V_{OUT}}\right)$$
(6)

Where V_{OUT} is the output voltage and I_{MAX} is the maximum sourcing current.

For a resistive load of value R_{LOAD}, the value of C_{OUT(max)} can be estimated from:

$$C_{OUT(max)} = \left[\frac{22 \times 10^{3} \times C_{T}}{R_{LOAD} \times \ell n \left[\frac{1}{1 - \frac{VOUT}{I_{MAX} \times R_{LOAD}}} \right]} \right]$$
(7)

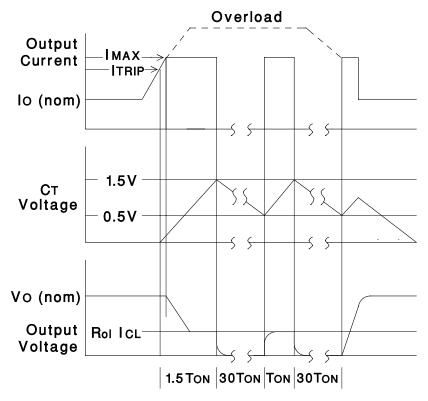


Figure 2. Load Curent, Timing Capacitor Voltage and Output Voltage of the UCC3918 Under Fault

UDG-97071



TYPICAL CHARACTERISTICS

REVERSE VOLTAGE COMPARATOR RESPONSE TIME

VIN COUT = 22 F RLOAD = 5 CIN = 5 F RIFAULT = 52.3 k RIMAX = 42.0 k 1 A O A Ch4 10.0mV M1.00µs Ch1 \ 4.0 V

Figure 3

INRUSH CURRENT LIMITING

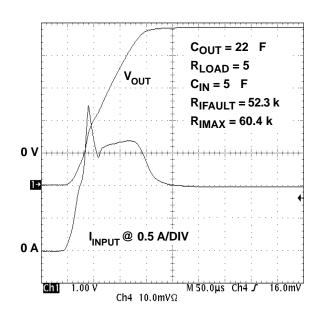


Figure 5

FAULT TIMING WAVEFORMS

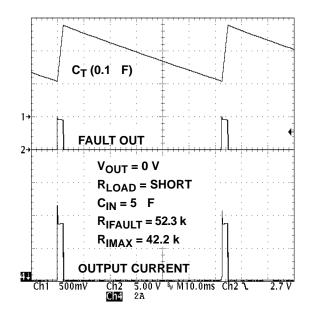


Figure 4

FAULT AND OUTPUT TURN-OFF DELAY FROM CT FAULT THRESHOLD

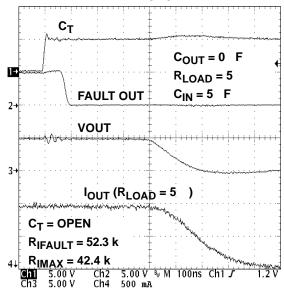
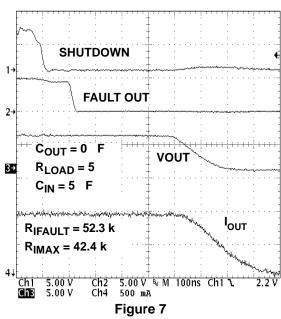


Figure 6

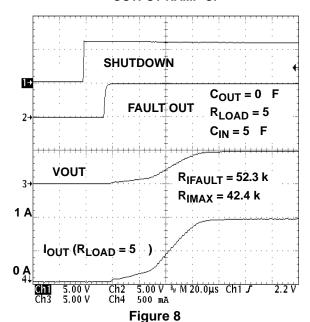


TYPICAL CHARACTERISTICS

PROPAGATION DELAY SHUTDOWN TO FAULT AND **OUTPUT RAMP-DOWN**



PROPAGATION DELAY ENABLE TO FAULT AND OUTPUT RAMP-UP



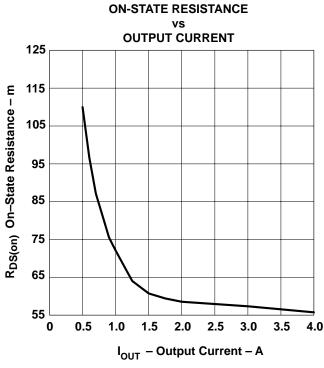
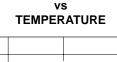


Figure 9

ON-STATE RESISTANCE



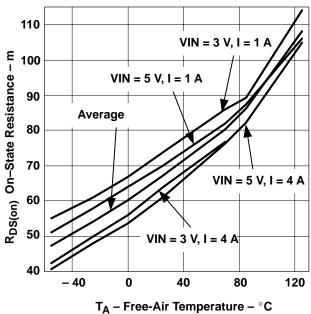


Figure 10



UCC3918 LOW ON-RESISTANCE HOT SWAP POWER MANAGER

SLUS384B - NOVEMBER 1999 - REVISED JUNE 2000

APPLICATION INFORMATION

safety considerations

Although the UCC3918 is designed to provide system protection for all fault conditions, all integrated circuits can ultimately fail short. For this reason, if the UCC3918 is intended for use in safety critical applications where UL[©] or some other safety rating is required, a redundant safety device such as a fuse should be placed in series with the power device. The UCC3918 prevents the fuse from blowing for virtually all fault conditions, increasing system reliability and reducing maintenance cost, in addition to providing the hot swap benefits of the device.



www.ti.com 11-Nov-2025

PACKAGING INFORMATION

Orderable part number	Status	Material type	Package Pins	Package qty Carrier	RoHS	Lead finish/	MSL rating/	Op temp (°C)	Part marking
	(1)	(2)			(3)	Ball material	Peak reflow	Peak reflow	
						(4)	(5)		
UCC3918DP	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3918DP
UCC3918DP.A	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3918DP
UCC3918DPG4	Active	Production	SOIC (D) 16	40 TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3918DP
UCC3918DPTR	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3918DP
UCC3918DPTR.A	Active	Production	SOIC (D) 16	2500 LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	0 to 70	UCC3918DP

⁽¹⁾ Status: For more details on status, see our product life cycle.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer: The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

⁽²⁾ Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

⁽⁴⁾ Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

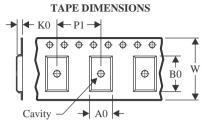
⁽⁶⁾ Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2025

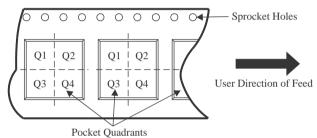
TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE

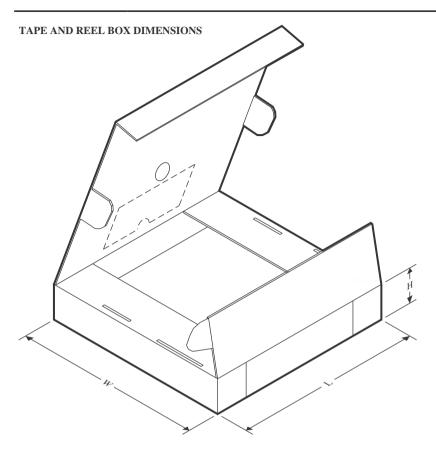


*All dimensions are nominal

Device		Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
UCC3918DPTR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2025



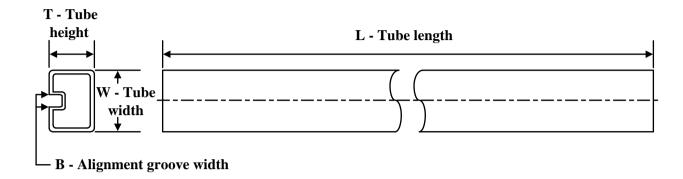
*All dimensions are nominal

	Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)	
ı	UCC3918DPTR	SOIC	D	16	2500	353.0	353.0	32.0	

PACKAGE MATERIALS INFORMATION

www.ti.com 23-Jul-2025

TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
UCC3918DP	D	SOIC	16	40	506.6	8	3940	4.32
UCC3918DP.A	D	SOIC	16	40	506.6	8	3940	4.32
UCC3918DPG4	D	SOIC	16	40	506.6	8	3940	4.32

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you fully indemnify TI and its representatives against any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale, TI's General Quality Guidelines, or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products. Unless TI explicitly designates a product as custom or customer-specified, TI products are standard, catalog, general purpose devices.

TI objects to and rejects any additional or different terms you may propose.

Copyright © 2025, Texas Instruments Incorporated

Last updated 10/2025